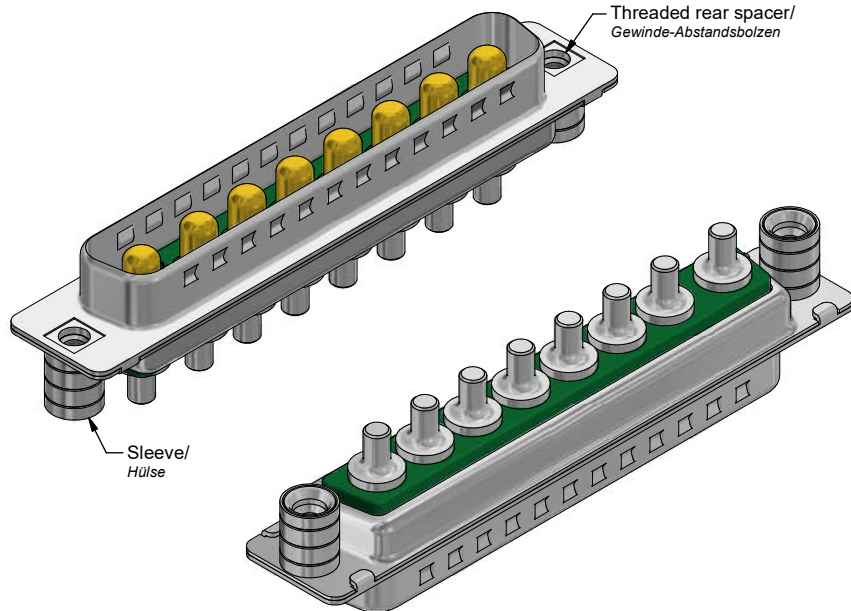
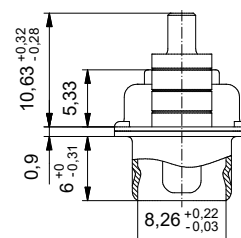
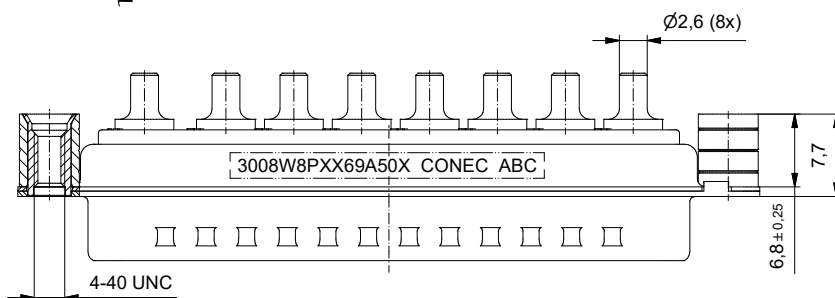
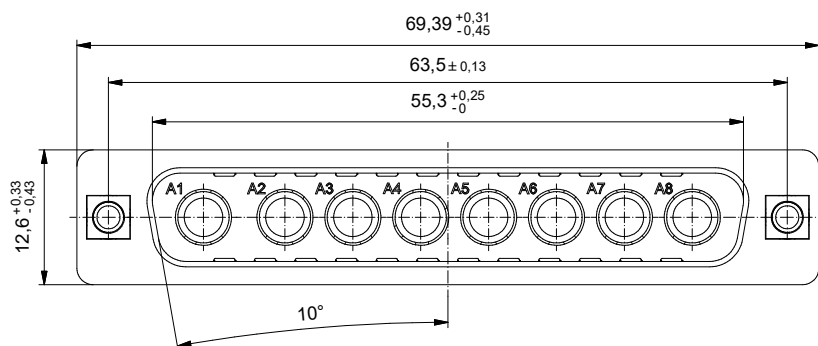
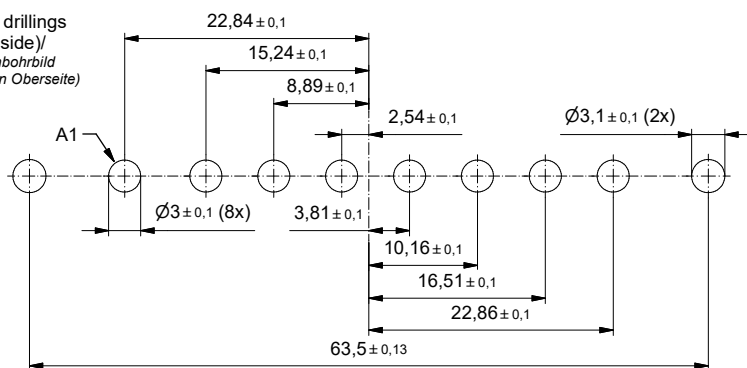




PCB hole drillings
(PCB top side)
Leiterplattenbohrbild
(Leiterplatten Oberseite)



Technical specification/

Technische Daten:

Dielectric withstanding voltage/ Spannungsfestigkeit:	1000 V, 50 Hz 1 min.
Current rating/ Strombelastbarkeit:	20 A
Insulation resistance/ Isolationswiderstand:	$\geq 5 \text{ G}\Omega$
Temperature range/ Temperaturbereich:	- 55 °C ... + 125 °C
Mating cycles/ Steckzyklen:	Quality class 3 = 50 Gütestufe 3

Materials/

Werkstoffe:

Contact/ Kontakt:	Cu alloy, Au over Ni
Insulator/ Isolierkörper:	PBT GF UL 94 V-0, green/grün
Shell/ Gehäuse:	Steel, Sn over Ni
Threaded rear spacer/ Gewinde-Abstandsbolzen:	Cu alloy, Sn over Ni
Sleeve/ Hülse:	Cu alloy, Sn over Ni

Installation specification/

Montagedaten:

Recommended torque value for thread/ Empfohlenes Drehmoment für Gewinde:	max. 6 in.LB/ max. 67 Ncm
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Part no. / Part marked/ Art.-Nr. / Bedruckung:		Contact plating/ Kontakt Veredelung:			
3008W8PXX69A50X		High power contact 20 A / Hochstromkontakt 20 A:		plating, mating area: Veredelung, Steckbereich: plating, termination side: Veredelung, Anschluss Seite:	gold flash over nickel Gold über Nickel tin over nickel Zinn über Nickel
				dim. in mm	
				D-SUB Combination Male 8W8P with threaded rear spacer	
				D-SUB Combination Stiffleiste 8W8P mit Gewinde-Abstandsbolzen	
Index: a Original		scale/maßstab:		dwg no /	
Status: Freigegeben		2:1		Z.-nr.: 13K1A6109	
RoHS compliant/ konform				DIN-A3	
				1 / 1	